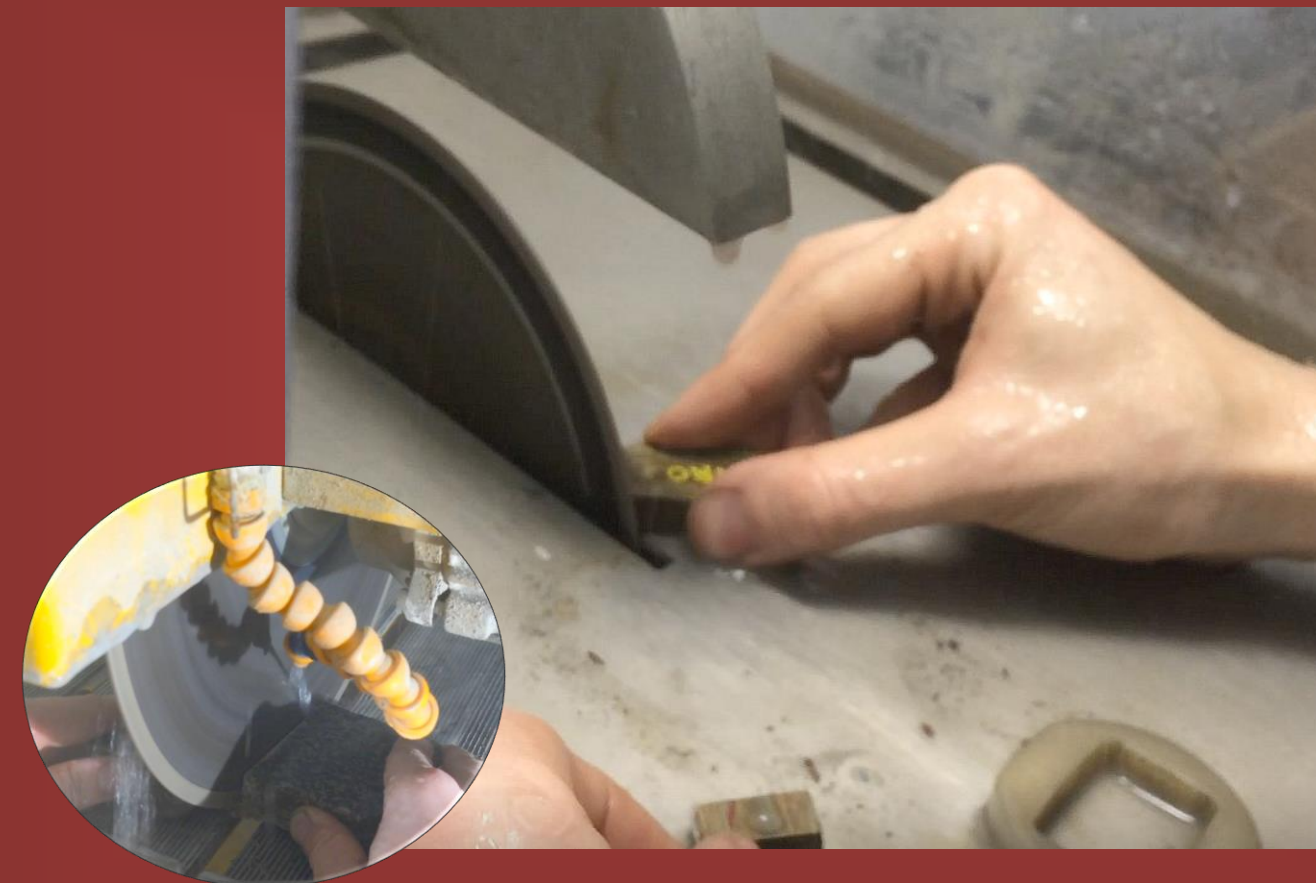


**Thin section preparation**

**Vinci's solution**

**Sectioning and trimming**



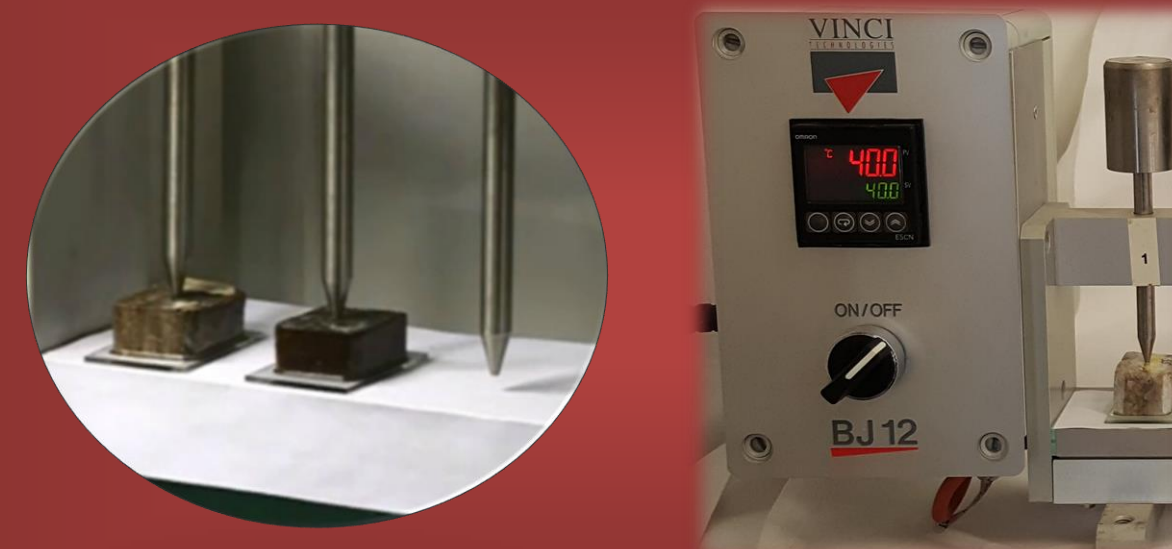
**Resin impregnation**



**Initial face grinding /lapping**



**Bonding**



**Thinning the specimen down to 100-500µ thickness**



**Grinding and lapping down to 30µ thickness**



**Polishing**

